

BASIC REQUIREMENT:

BOARD OUTLINE: 202mm X 79mm
HOLE PLATING THICKNESS 1 Oz MINIMUM
SOLDER MASK: GREEN, BOTH SIDES
DO NOT COVER HOLES WITH SOLDER MASK
SILKSCREEN: WHITE, TOP SIDE ONLY
REMOVE SILKSCREEN FROM SOLDER MASK VOIDS
SURFACE FINISH: TIN-LEAD HAL

2-LAYER BOARD, 1.6 mm THICKNESS

TOP SIDE — 2 oz. COPPER AFTER PLATING
FR-4 CORE
BOTTOM SIDE — 2 oz. COPPER AFTER PLATING
MATERIAL TO BE FR-4 (KB GRADE A) UNLESS OTHERWISE SPECIFIED

